

#### 650V 8A 1.18Ω N-ch Power MOSFET

## **Description**

DT2 MOS is DIN-TEK 2nd generation VDMOS family that is dramatic reduction in on-resistance and ultra-low gate charge for applications requiring high power density and high efficiency. And it is very robust and RoHS compliant.

Typ.R<sub>DS(on)</sub>=1.18 $\Omega$ @V<sub>GS</sub>=10V

100% avalanche tested

**RoHS Compliant** 

**TO-220** 









TO-251-L4.0

TO-251-L9.4





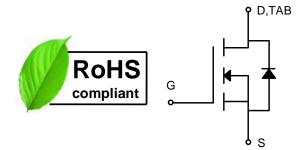


# **Applications**

**SMPS** 

**Features** 

- Charger
- DC-DC



#### **Absolute Maximum Ratings** (Tc=25℃)

Parameter	Symbol	DTP8N65	DTU8N65/DTL8N65	DTP8N65F	Unit
Drain-source voltage	V <sub>DSS</sub>	650			V
Gate-source voltage	V <sub>GS</sub>		±30		V
Continuous drain current	I <sub>D</sub>		8		Α
Pulsed drain current <sup>1</sup>	I <sub>DM</sub>		32		Α
Avalanche energy, single pulse <sup>2</sup>	Eas	105			mJ
Power dissipation	P <sub>D</sub>	125 55 38		38	W
Derate above 25°C		1	0.4	0.3	W/°C
Operating junction temperature	Tj	-55~150			°C
Storage temperature	T <sub>stg</sub>	-55~150			°C
Continuous diode forward current	Is	8			Α
Diode pulse current <sup>1</sup>	I <sub>Spulse</sub>		32		Α

#### **Thermal Characteristic**

Thermal resistance, junction-to-case	R <sub>θJC</sub>	1	2.27	3.29	°C/W
Thermal resistance,junction-to-ambient	$R_{\theta JA}$	62.5	110	62.5	°C/W



# DTP8N65 DTP8N65F DTU8N65 DTL8N65

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Тур.

				Min.	Тур.	Max.	
Drain-source break down voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	Tc=25°C	650	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =250µA, V <sub>DS</sub> =V <sub>GS</sub>	TJ=25°C	2.0	-	4.0	V
Drain-source leakage current		V <sub>DS</sub> =650V, V <sub>GS</sub> =0V	TJ=25°C	-	-	1	μΑ
	IDSS	V <sub>DS</sub> =520V, V <sub>GS</sub> =0V	T <sub>J</sub> =125°C	-	-	100	μA
Gate-source leakage current,forward	Igssf	V <sub>DS</sub> =0V, V <sub>GS</sub> =30V	TJ=25°C	-	-	100	nA
Gate-source leakage current,reverse	Igssr	V <sub>DS</sub> =0V, V <sub>GS</sub> =-30V	TJ=25°C	-	-	-100	nA
Drain-source on-state resistance <sup>3</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =4A	TJ=25°C	-	1.18	1.36	Ω
Transconductance <sup>3</sup>	Gfs	V <sub>DS</sub> =20V	TJ=25°C	-	6.2	-	S
Dynamic Characteristics of I	MOSFET	(Tc=25°C)		Min.	Тур.	Max.	
Input capacitance	Ciss	f_1MHz \/25\/		-	1103	-	pF
Output capacitance	Coss	f=1MHz, V <sub>DS</sub> =25V,		_	94	_	пF

Output capacitance	Coss	V <sub>GS</sub> =0V	-	94	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	- VGS=UV	-	10	-	pF
Gate to source charge	Qgs	V <sub>DD</sub> =520V	-	7.4	-	nC
Gate to drain charge	$Q_{gd}$	I <sub>D</sub> =8A	-	7	-	nC
Total gate charge	0.	Ves= 0 to 10V	_	24.4	_	nC

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Rise time	tr	V <sub>DS</sub> =325V, I <sub>D</sub> =8A,	-	21	-	ns
Turn-off delay time	t <sub>d off</sub>	$R_G=25\Omega$ , $V_{GS}=0$ to 10V	-	80	-	ns
Fall time	t <sub>f</sub>		-	30	-	ns

# Characteristics of Body Diode $(T_c=25^{\circ})$

**Electrical Characteristics of MOSFET** 

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Forward voltage	$V_{SD}$	I <sub>SD</sub> =8A, V <sub>GS</sub> =0V	-	1	1.4	V
Reverse recovery time	t <sub>rr</sub>	V <sub>DS</sub> =50V, I <sub>S</sub> =8A,	-	280	-	ns
Reverse recovery current	Irr	V <sub>GS</sub> =10V	-	12	-	Α
Recovery charge	Qrr	di/dt=100A/µs	-	1.7	-	μC

#### Notes:

- 1. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$  =150°C.
- 2. The E\_{AS} data shows Max. rating . The test condition is  $V_{DD}$  =50V,  $V_{GS}$  =10V, L=10mH, I\_{AS} =4.6A,Tc=25°C.
- 3. The data tested by pulsed , pulse width  $\leq 300 \mu s$  , duty cycle  $\leq 2\%.$

#### TYPICAL CHARACTERISTICS

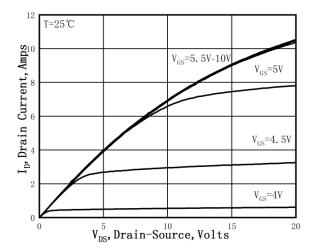


Figure 1.On-Region Characteristics

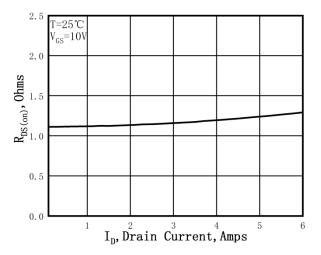


Figure 3. Static Drain-Source On Resistance

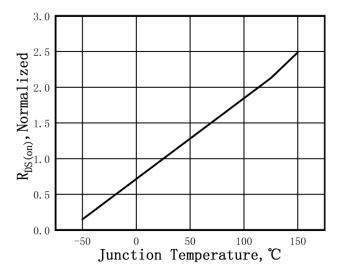


Figure 5. Normalized R<sub>DS(on)</sub> vs.Temperature

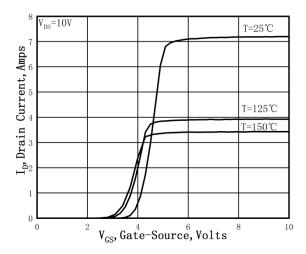


Figure 2. Transfer Characteristics

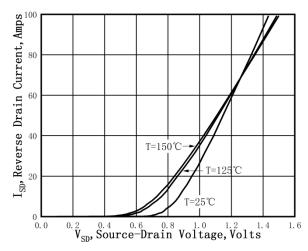


Figure 4. Typical Body Diode Transfer Characteristics

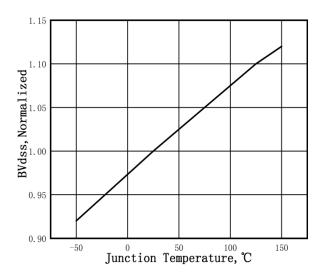


Figure 6. Normalized BV<sub>DSS</sub> vs.Temperature

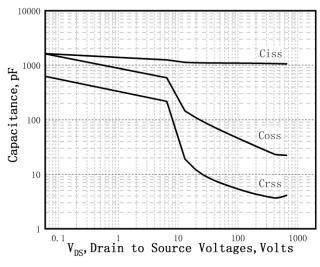


Figure 7. Capacitance Characteristics

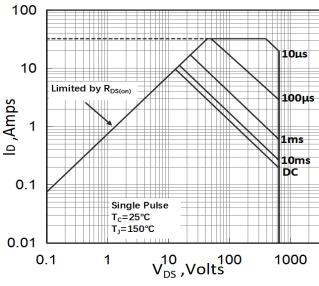


Figure 9. Maximum Safe Operating Area

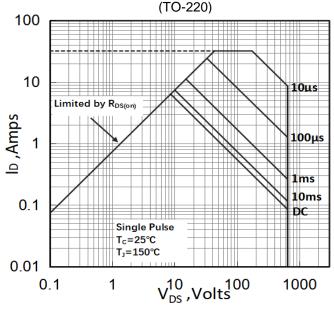


Figure 11. Maximum Safe Operating Area (TO-252/TO-251)

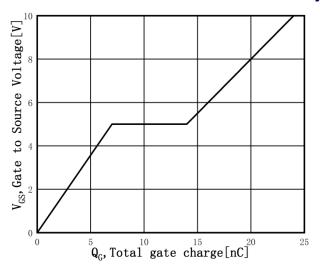


Figure 8. Gate Charge Characteristics

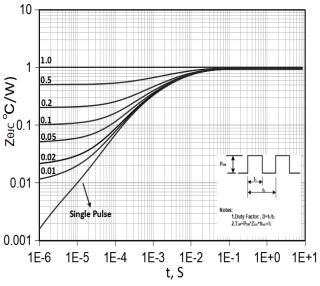


Figure 10. Transient Thermal Response Curve

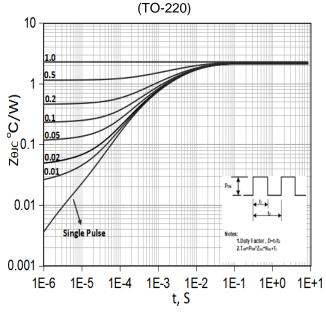


Figure 12. Transient Thermal Response Curve (TO-252/TO-251)



# DTP8N65 DTP8N65F DTU8N65 DTL8N65

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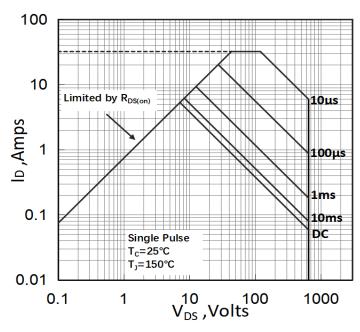


Figure 13. Maximum Safe Operating Area (TO-220F)

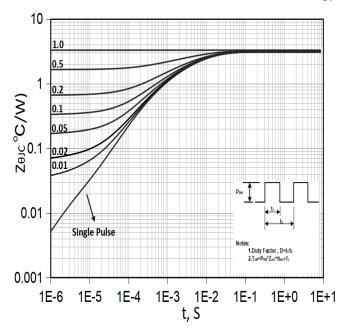
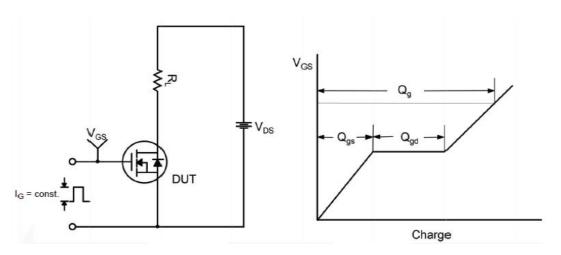


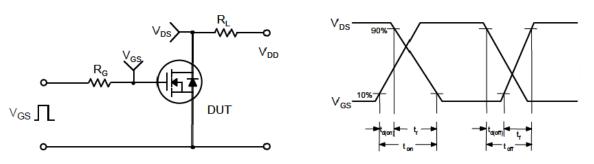
Figure 14. Transient Thermal Response Curve (TO-220F)

### **Test Circuit**

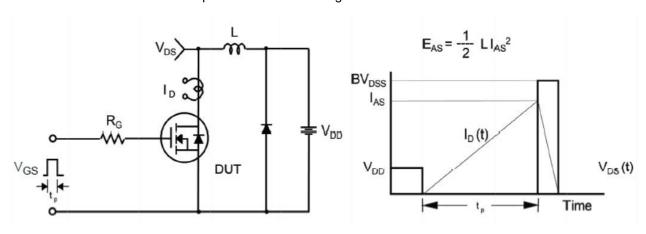
#### Gate Charge Test Circuit &Waveform



#### Switching Test Circuit &Waveforms



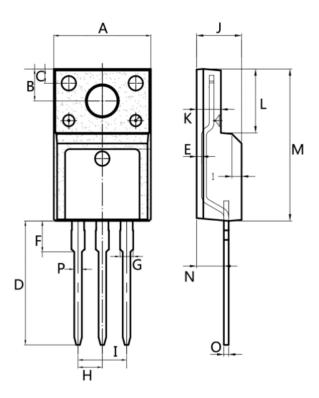
### Unclamped Inductive Switching Test Circuit &Waveforms





### **Mechanical Dimensions for TO-220F**

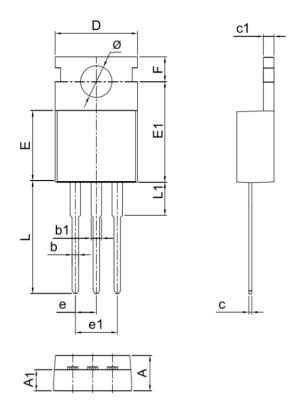
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# COMMON DIMENSIONS MM

SYMBOL	MM				
STIVIBUL	MIN	MAX			
Α	9.95	10.36			
В	2.95	3.55			
С	1.25	1.6			
D	12.64	13.5			
E	0.40	0.60			
F	2.80	3.80			
G	1.14	1.58			
Н	2.44	2.64			
	4.88	5.26			
J	4.50	4.90			
K	2.34	2.80			
L	6.48	6.90			
М	15.40	16.07			
N	2.66	3.50			
0	0.40	0.64			
Р	0.70	0.94			

#### **Mechanical Dimensions for TO-220**



#### **COMMON DIMENSIONS**

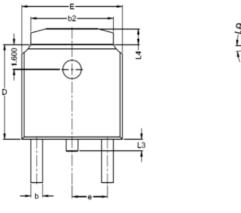
SYMBOL	М	М
STIVIBUL	MIN	MAX
Α	4.30	4.70
A1	2.30	2.82
b	0.70	0.94
b1	1.17	1.41
С	0.30	0.64
c1	1.17	1.44
D	9.70	10.20
Е	8.50	9.30
E1	12.00	12.50
е	2.44	2.64
e1	4.88	5.26
F	2.60	2.94
L	13.00	14.00
L1	3.385	4.20
Ø	3.74	3.95

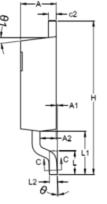


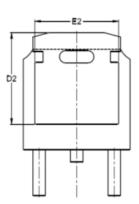
# **Mechanical Dimensions for TO-252**

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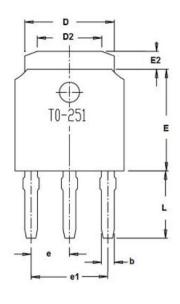


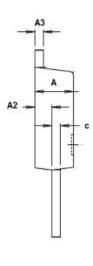


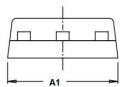


SYMBOL	MM				
STIVIDUL	MIN	MAX			
Α	2.10	2.50			
A1	0	0.15			
b	0.7	0.9			
b2	5.13	5.54			
С	0.44	0.65			
c2	0.45	0.65			
D	6.00	6.20			
D2	5.37	5.78			
Е	6.30	6.90			
E2	4.90	5.30			
е	2.23	2.33			
Н	9.7	10.5			
L	1.38	1.73			
L1	2.58	3.00			
L2	0.50	0.52			
L3	0.60	1.00			
L4	0.81	1.42			

### **Mechanical Dimensions for TO-251-L4.0**





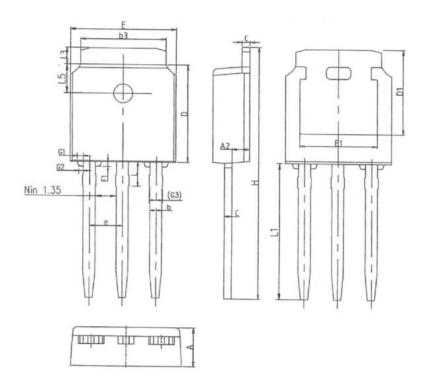


SYMBOL	MM			
STIMBUL	MIN	MAX		
Α	2.15	2.45		
A1	6.3	6.9		
A2	0.9	1.1		
A3	Typ0.5			
b	0.74	0.86		
С	0.9	1.1		
D	5.33	5.53		
D2	3.56	4.05		
Е	6.0	6.2		
e	Typ2.29			
e1	Typ4.58			
L	3.7	4.3		

COMMON DIMENSIONS



### **Mechanical Dimensions for TO-251-L9.4**



#### **COMMON DIMENSIONS**

SYMBOL	MM		
STIVIBUL	MIN	MAX	
Α	2.20	2.40	
A2	0.97	1.17	
b	0.58	0.78	
b3	5.20	5.50	
С	0.43	0.63	
D	5.98	6.22	
D1	5.30	REF	
Е	6.40	6.80	
е	1.98	2.59	
F1	0.23	0.37	
G2	0.33	0.47	
G3	0.64	0.80	
Н	16.22	16.82	
L1	9.15	9.65	
L3	0.88	1.28	

# **Ordering Information**

Part	Package	Marking	Packing method	Minimum packing number
DTP8N65F	TO-220F	DTP8N65F	Tube	50 / Tube
DTP8N65	TO-220	DTP8N65	Tube	50 / Tube
DTU8N65	TO-252	DTU8N65	Tape and reel	2.5K / Reel
DTL8N65	TO-251-L4.0	DTL8N65	Tube	80 / Tube
DILONOS	TO-251-L9.4	DILONOS	Tube	75 / Tube

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